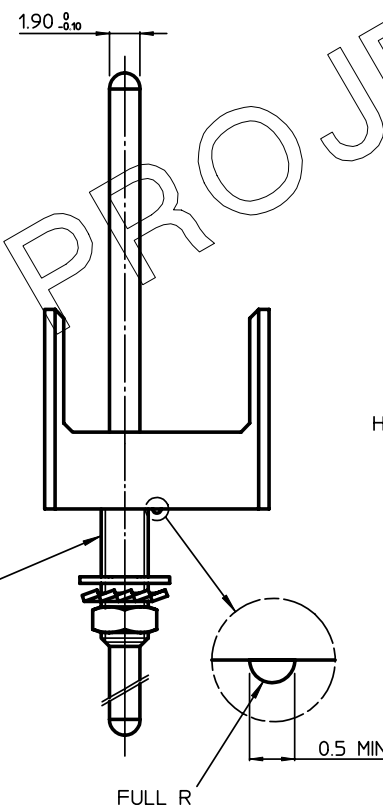
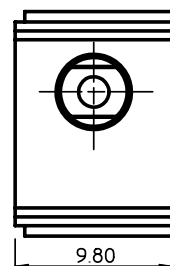
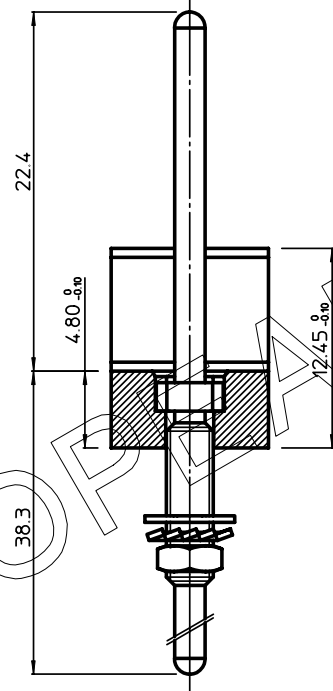
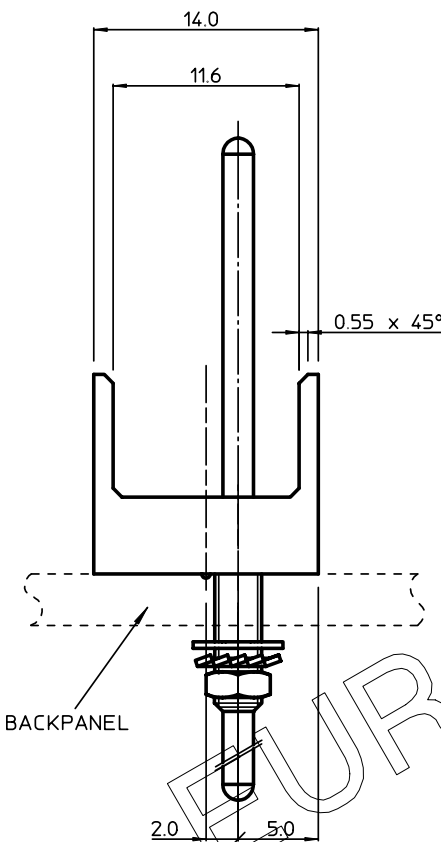


BACKPANEL HOLE LAY-OUT
COMPONENT SIDE $\phi 0.1$
ALL HOLES $\phi 3.00^{+0.02}_{-0.10}$
NOTE 3

2.00

TO STANDARD
HOLE PATTERN
FOR SIGNAL
MODULELEAD FREE INDICATOR : LF = LEAD FREE
HM2G07--

Cat No	Plating Details
HM2G07	3-5μ SnPb (90/10) OVER 3μ Ni MIN.
HM2G07LF	3-5μ Sn (Matl Tin) OVER 3μ Ni MIN.

NOTES

1. MATERIAL HOUSING : GLASS FILLED POLYMER.
2. MATERIAL GUIDE PIN : 1/2 HARD BRAS.
3. PLATED THRU HOLE FOR POWER APPLICATION ONLY.
4. THE PRODUCT (LF) MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008

1DEC ± 0.2 2DEC ± 0.1 ANGLES $\pm 1^\circ$	APPR.	DATE	SIGN.	MILLIPACS 2 / GUIDING SYSTEM (for backpanel)
WE RESERVE THE RIGHT TO CHANGE DIMENSIONS OR REQUIREMENTS WITHOUT PRIOR NOTICE.	DRAFT	1999-10-14	G. Nys	CAT. No. HM2G07 (--)
ALL DIMENSIONS IN MM	CHECKED			FCI www.fciconnect.com
	PROD. MGR.			SCALE 3/1
	PR. ENG. MGR.			BS,C ,201911,013
	PR. MGT. MGR.			B
	REFERENCES			STATUS: Released
				CUSTOMER DRAWING REVISION